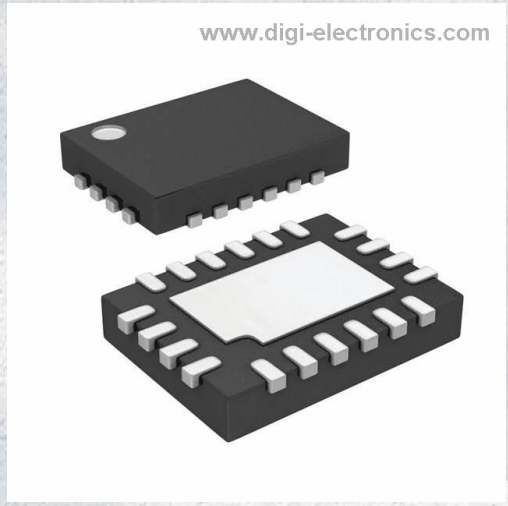
DSC557-04224KI0 Datasheet



DiGi Electronics Part Number	DSC557-04224KI0-DG
Manufacturer	Microchip Technology
Manufacturer Product Number	DSC557-04224KI0
Description	MEMS OSC XO 100.0000MHZ HCSL LVP
Detailed Description	PCI Express (PCIe) Clock Generator IC 460MHz 1 Output

https://www.DiGi-Electronics.com

Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
DSC557-04224KI0	Microchip Technology
Series:	Product Status:
DSC557-04	Active
DiGi-Electronics Programmable:	PLL:
Not Verified	Yes
Main Purpose:	Input:
PCI Express (PCIe)	-
Output:	Number of Circuits:
HCSL, LVPECL	1
Ratio - Input:Output:	Differential - Input:Output:
0:03	No/Yes
Frequency - Max:	Voltage - Supply:
460MHz	2.25V ~ 3.6V
Operating Temperature:	Mounting Type:
-40°C ~ 85°C	Surface Mount
Package / Case:	Base Product Number:
20-VFQFN Exposed Pad	DSC557

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	3 (168 Hours)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8542.39.0001	

DSC557-04

Crystal-less™ Three Output PCIe Clock Generator

General Description

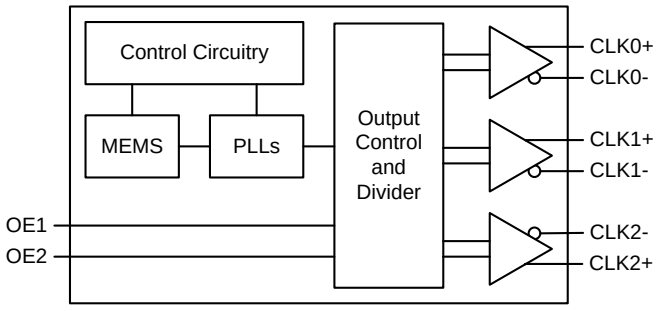
The DSC557-04 is a Crystal-less™, three output PCI express clock generator meeting Gen1, Gen2, and Gen3 specifications. The clock generator uses proven silicon MEMS technology to provide excellent jitter and stability over a wide range of supply voltages and temperatures. By eliminating the external quartz crystal, MEMS clock generators significantly enhance reliability and accelerate product development, while meeting stringent clock performance criteria for a variety of communications, storage, and networking applications.

DSC557-04 has an Output Enable / Disable feature allowing it to disable all outputs when OE1 and OE2 are low. OE1 controls CLK0 and OE2 controls CLK1/2. CLK1/2 are synchronous PCIe clocks. See the OE function diagram for more detail. The device is available in a 20 pin QFN. Additional output formats are in any combination of LVPECL, LVDS, and HCSL.

Features

- **Meets PCIe Gen1, Gen2 & Gen3 specs**
- **Available Output Formats:**
  - HCSL, LVPECL, or LVDS
  - Mixed Outputs: LVPECL/HCSL/LVDS
- **Wide Temperature Range**
  - Ext. Industrial: -40° to 105° C
  - Industrial: -40° to 85° C
  - Ext. commercial: -20° to 70° C
- **Supply Range of 2.25 to 3.6 V**
- **Low Power Consumption**
  - 30% lower than competing devices
- **Excellent Shock & Vibration Immunity**
  - Qualified to MIL-STD-883
- **Available Footprints:**
  - 20 QFN
- **Lead Free & RoHS Compliant**
- **Short Lead Time: 2 Weeks**

Block Diagram



* Clk0+/-, Clk1+/- and Clk2 +/- are 100 MHz as per PCIe standards. For other frequencies, please contact the factory.

Applications

- **Communications/Networking**
  - **Ethernet**
  - **1G, 10GBASE-T/KR/LR/SR, and FcoE**
  - **Routers and Switches**
  - **Gateways, VoIP, Wireless AP's**
  - **Passive Optical Networks**
- **Storage**
  - **SAN, NAS, SSD, JBOD**
- **Embedded Applications**
  - **Industrial, Medical, and Avionics**
  - **Security Systems and Office Automation**
  - **Digital Signage, POS and others**
- **Consumer Electronics**
  - **Smart TV, Bluray, STB**

Specifications (Unless specified otherwise: T=25° C, VDD =3.3V)

Parameter		Condition	Min.	Typ.	Max.	Unit
Supply Voltage[1]	V_{DD}		2.25		3.6	V
Supply Current	I_{DD}	EN pin low – outputs are disabled		42	46	mA
Supply Current[2] (Two HCSL Outputs)	I_{DD}	EN pin high – outputs are enabled R_L=50 Ω, F_{O1}=F_{O2}=F_{O3}=100 MHz		100		mA
Frequency Stability	Δf	Includes frequency variations due to initial tolerance, temp. and power supply voltage			±100 ±50	ppm
Startup Time[3]	t_{SU}	T=25°C			5	ms
Input Logic Levels Input logic high Input logic low	 V_{IH} V_{IL}		 0.75xV_{DD} -		 - 0.25xV_{DD}	V
Output Disable Time[4]	t_{DA}				5	ns
Output Enable Time	t_{EN}				20	ns
Pull-Up Resistor[2]		Pull-up on OE pin		40		kΩ

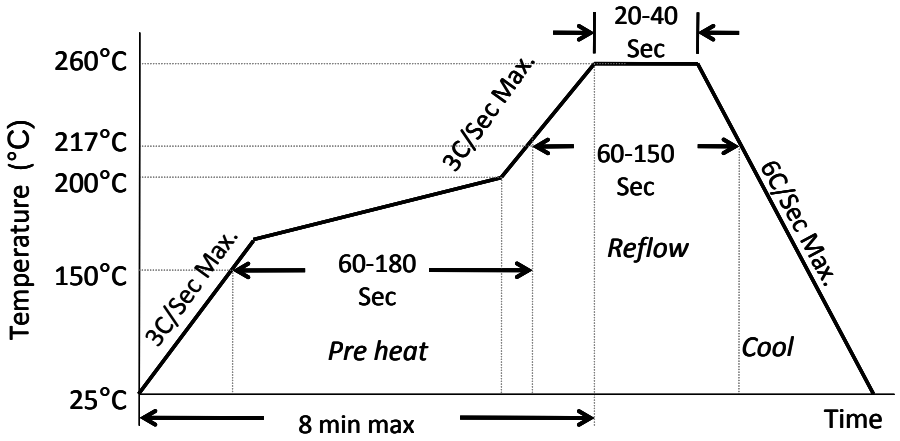
HCSL Outputs[6]						
Parameter		**Condition**	**Min.**	**Typ.**	**Max.**	**Unit**
Output Logic Levels Output logic high Output logic low	 V_{OH} V_{OL}	R_L=50Ω	 0.725 -		 - 0.1	V
Pk to Pk Output Swing		Single-Ended		750		mV
Output Transition time[4] Rise Time Fall Time	 t_R t_F	20% to 80% R_L=50Ω, C_L= 2pF	200		400	ps
Frequency	f_0	Single Frequency	2.3	100[7]	460	MHz
Output Duty Cycle	SYM	Differential	48		52	%
Period Jitter[5]	J_{PER}	F_{O1}=F_{O2}= F_{O3} =100 MHz		2.5		ps_{RMS}
Jitter, Phase (Common Clock Architecture)	T_J	PCIe Gen 1.1		22.7	86.0[8]	ps_{p-p}
	$J_{RMS-CCHF}$	PCIe Gen 2.1, 1.5MHz to Nyquist		2.20	3.1[8]	ps_{RMS}
	$J_{RMS-CCLF}$	PCIe Gen 2.1, 10 kHz to 1.5 MHz		0.08	3.0[8]	ps_{RMS}
	J_{RMS-CC}	PCIe Gen 3.0		0.37	1.0[8]	ps_{RMS}
Integrated Phase Noise (Data Clock Architecture)	$J_{RMS-DCHF}$	PCIe Gen 2.1, 1.5MHz to Nyquist		2.15	4.0[8]	ps_{RMS}
	$J_{RMS-DCLF}$	PCIe Gen 2.1, 10 kHz to 1.5 MHz		0.06	7.5[8]	ps_{RMS}
	J_{RMS-DC}	PCIe Gen 3.0		0.32	1.0[8]	ps_{RMS}

Notes:
1. V_{DD} should be filtered with 0.01uf capacitor.
2. Output is enabled if OE pin is floated or not connected.
3. t_{su} is time to 100PPM stable output frequency after V_{DD} is applied and outputs are enabled.
4. Output Waveform and Connection Diagram define the parameters.
5. Period Jitter includes crosstalk from adjacent output.
6. Contact Sales@Discera.com for alternate output options (LVPECL, LVDS, LVCMOS).
7. Contact Sales@Discera.com for alternative frequency options
8. Jitter limits established by Gen 1.1, Gen 2.1, and Gen 3.0 PCIe standards.

Absolute Maximum Ratings

Item	Min	Max	Unit	Condition
Supply Voltage	-0.3	+4.0	V	
Input Voltage	-0.3	V_{DD}+0.3	V	
Junction Temp	-	+150	°C	
Storage Temp	-55	+150	°C	
Soldering Temp	-	+260	°C	40sec max.
ESD HBM MM CDM	-	 4000 400 1500	V	

Solder Reflow Profile

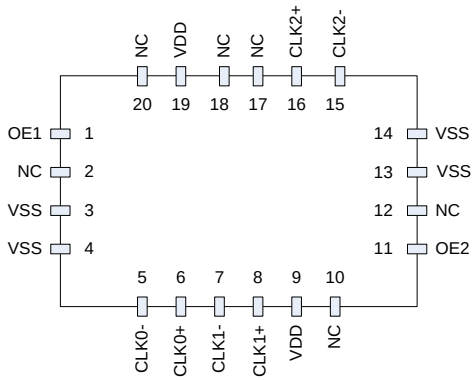


20 QFN MSL 1 @ 260°C refer to JSTD-020C	
Ramp-Up Rate (200°C to Peak Temp)	3°C/Sec Max.
Preheat Time 150°C to 200°C	60-180 Sec
Time maintained above 217°C	60-150 Sec
Peak Temperature	255-260°C
Time within 5°C of actual Peak	20-40 Sec
Ramp-Down Rate	6°C/Sec Max.
Time 25°C to Peak Temperature	8 min Max.

Pin Description (20 QFN)

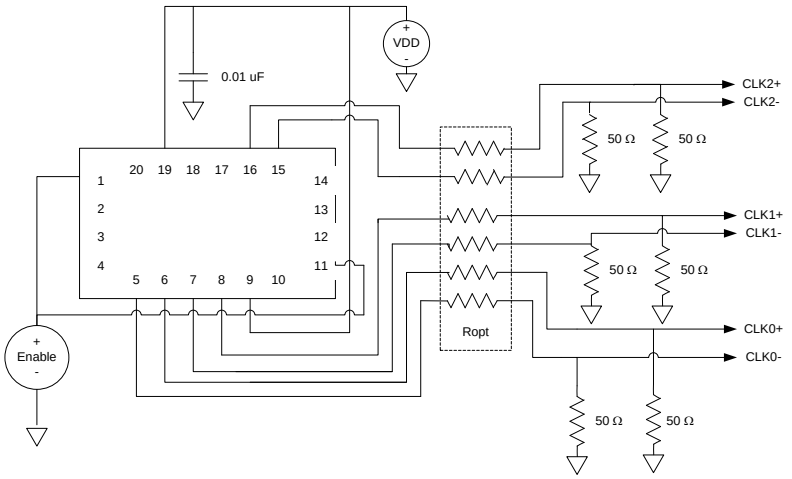
Pin No.	Pin Name	Pin Type	Description
1	OE1	I	Output Enable; active high
2	NC	NA	Leave unconnected or grounded
3	VSS	Power	Ground
4	VSS	Power	Ground
5	CLK0-	O	Complement output of differential pair
6	CLK0+	O	True output of differential pair
7	CLK1-	O	Complement output of differential pair
8	CLK+	O	True output of differential pair
9	VDD	Power	Power Supply
10	NC	NA	Leave unconnected or grounded
11	OE2	I	Output Enable; active high
12	NC	NA	Leave unconnected or grounded
13	VSS	Power	Ground
14	VSS	Power	Ground
15	CLK2-	O	Complement output of differential pair
16	CLK2+	O	True output of differential pair
17	NC	NA	Package pin is Not Connected to internal IC or MEMS
18	NC	NA	Package pin is Not Connected to internal IC or MEMS
19	VDD	Power	Power Supply
20	NC	NA	Leave unconnected or grounded

Pin Diagram (20 QFN)

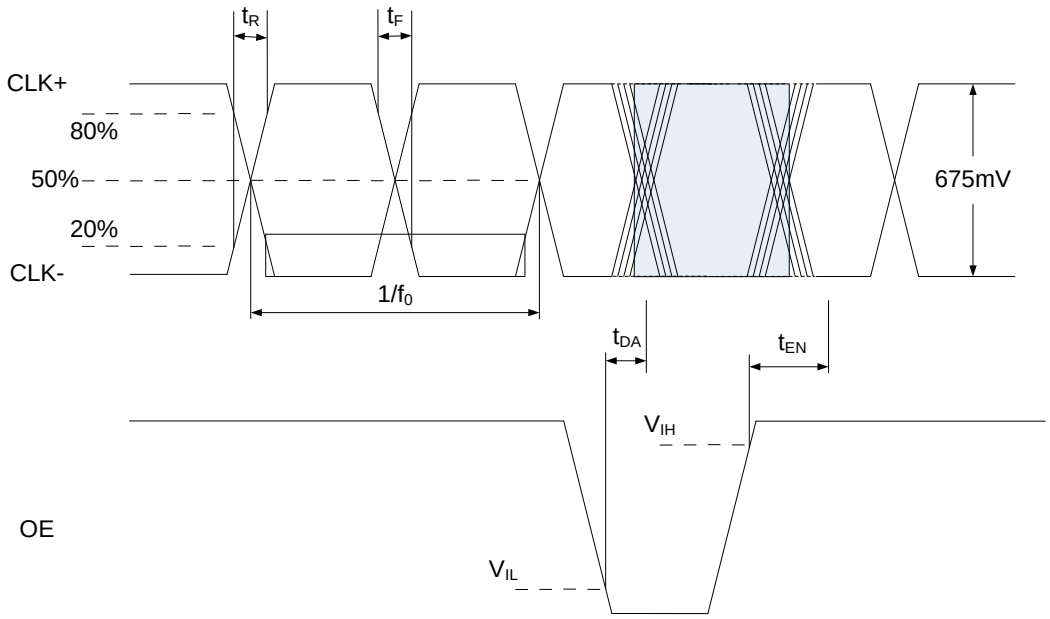


20 QFN 5.0 x 3.2mm

Connection Diagram (20 QFN Three HCSL Outputs)

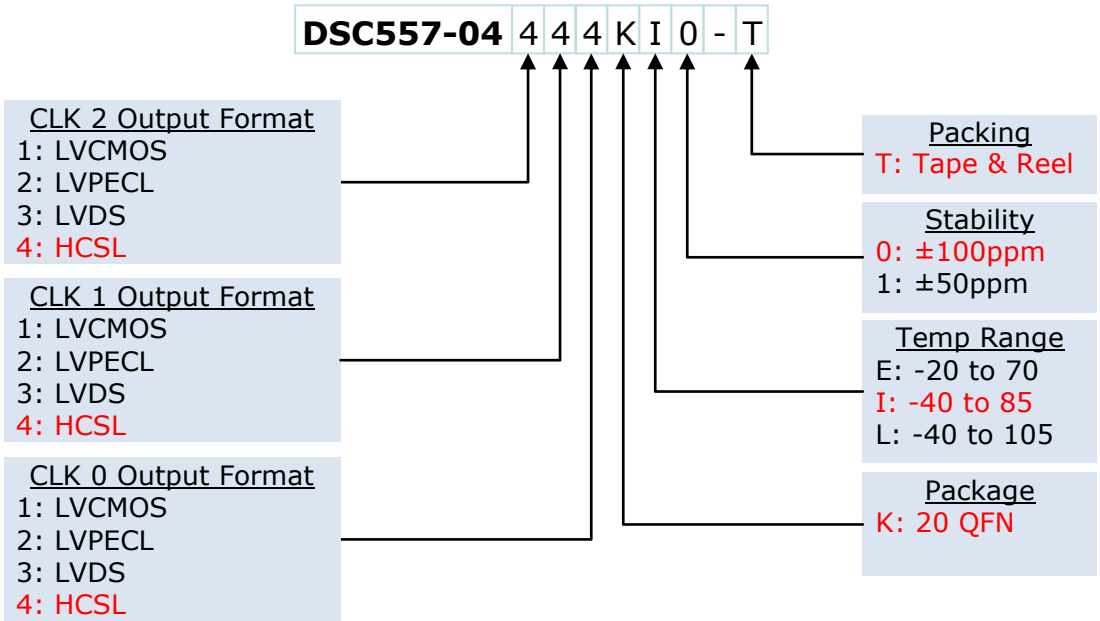


OE Function and Output Waveform: HCSL



			Synchronous	
OE1	OE2	CLK0	CLK1	CLK2
0	0	Hi-Z	Hi-Z	Hi-Z
0	1	Hi-Z	EN	EN
1	0	EN	Hi-Z	Hi-Z
1	1	EN	EN	EN

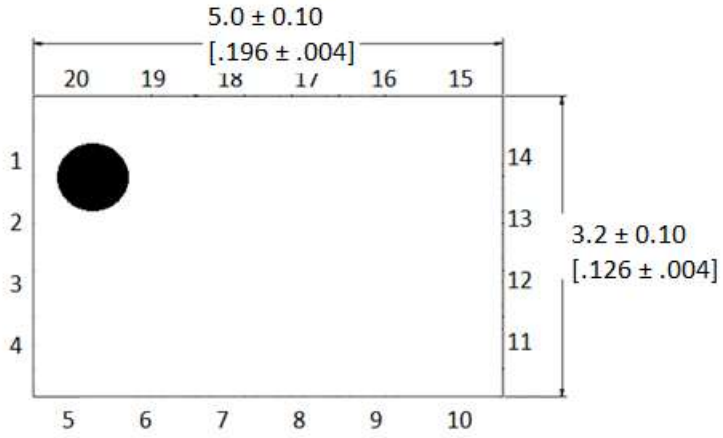
Ordering Information



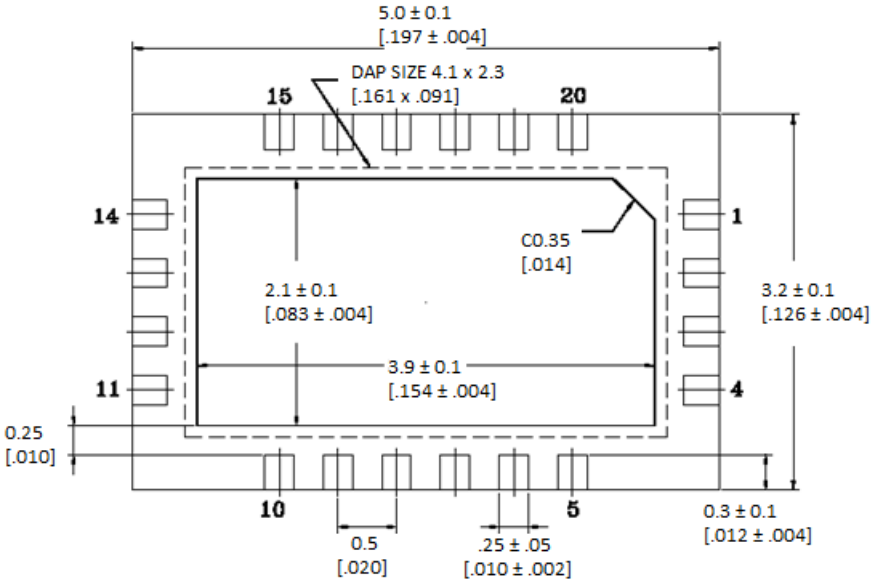
Package Dimensions

20 QFN, 5.0 x 3.2 mm

Top View
units: mm[inches]

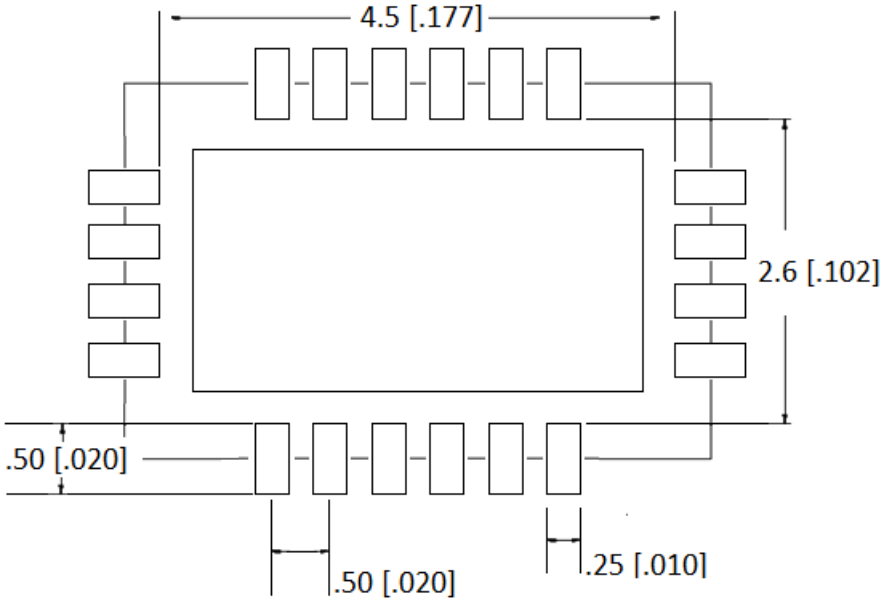


Bottom View
units: mm[inches]±



Side View
units: mm[inches]

Recommended Solder Pad Layout
units: mm[inches]



*Connect the center pad to VSS for best thermal performance

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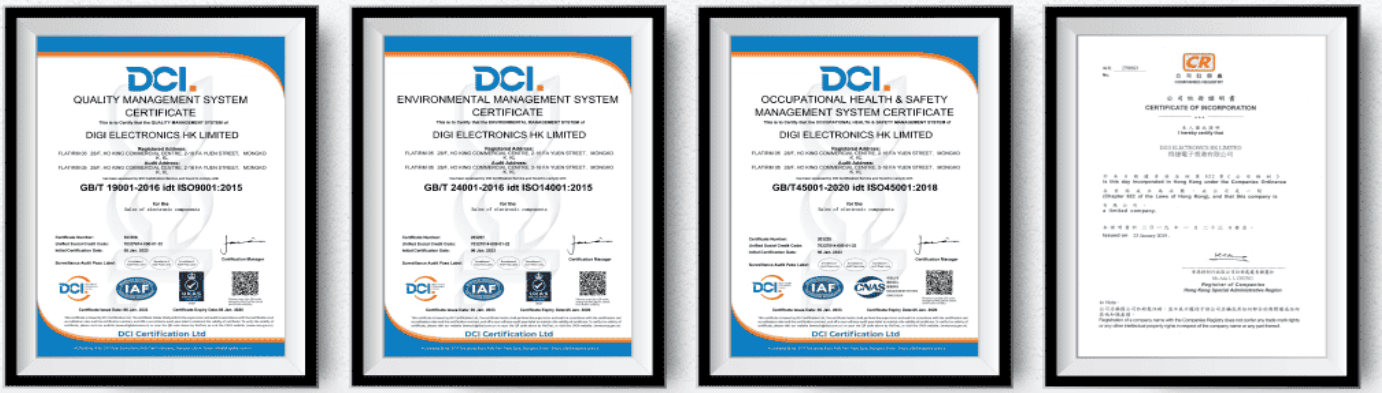

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